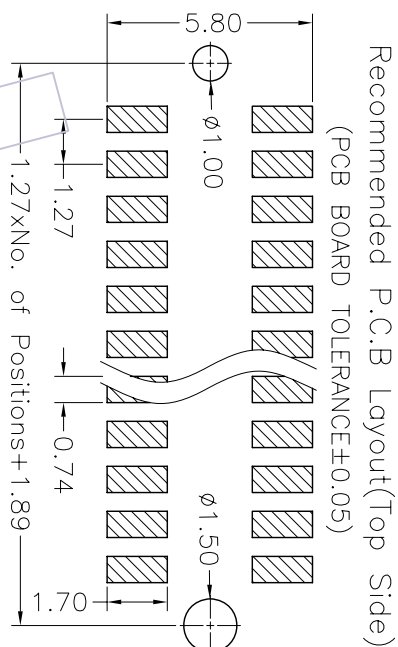
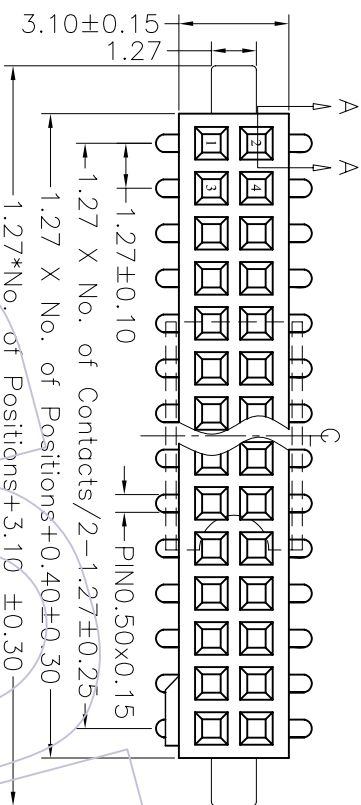


HSP

NOTES:

Current Rating: 1.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩ/Min
 Operation Temperature: -40°C to +105°C

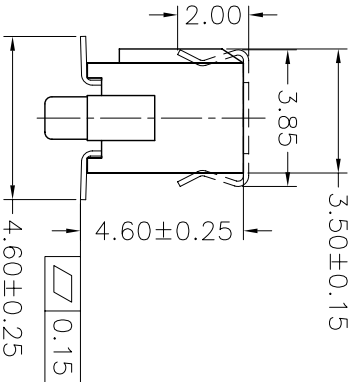
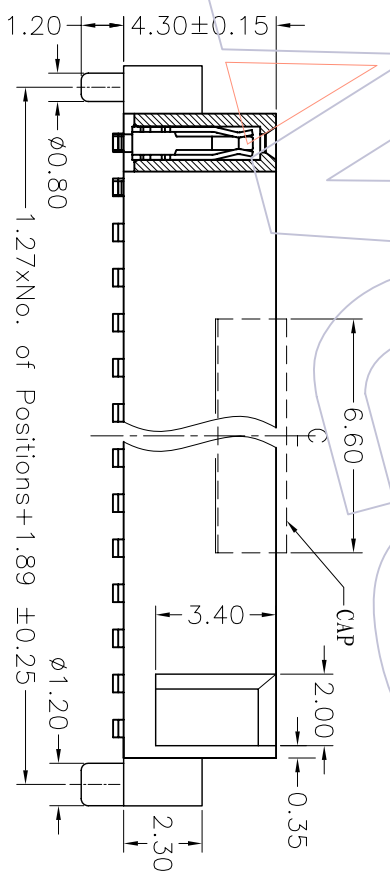
Contact Material: Phosphor Bronze
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T+30%G.F.(UL94V-0)



Ordering Information

2344 - 2 XX M XX CUNT 4

No. of Pins per ROW: 02-50/N
 Contact Plating: T=Tube, R=Tape&Reel+CAP
 GI=3μ"Gold, G2=5μ"Gold, G3=10μ"Gold, G4=15μ"Gold, G5=30μ"Gold
 S0=Gold Flash/Tin, S1=3μ"Gold/Tin, S2=5μ"Gold/Tin, S3=10μ"Gold/Tin, S4=15μ"Gold/Tin, S5=30μ"Gold/Tin, SN=Tin



SECTION A-A

OPERATION	DRAW	SCALE	5:1
X.X	DESIGN	UNIT	mm
X.XX	CHECK	SIZE	A4
X.XXX	APPROVE	SHEET	1/1
Angle	APPROVE	TITLE:	Customer NO.
± 3'			

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE
A0	08/02/16	NEW		

WCON 维峰五金电子有限公司	
WAFER HARDWARE ELECTRONICS CO.,LTD	
PART NO.	2344-2XXMXXCUNT4
TITLE:	FIG 1. 27mm DUAL SMT H=4.30 WITH DIFFERENT POST AND BUMP